



# Product Change Notification

## 113107 - 00

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# Product Change Notification

**Change Notification #:** 113107 - 00  
**Change Title:** Intel® NUC Board BLKDE3815TYBE, 10 Pack  
Intel® NUC Kit BLKDE3815TYKHOE, 5 Pack  
PCN 113107-00  
Product Design  
Change to support Intel® Atom™ Processors E3815  
**Date of Publication:** September 18, 2014

**Key Characteristics of the Change:**  
Product Design

## Forecasted Key Milestones:

|   |                      |
|---|----------------------|
| <b>Date Customer Must be Ready to Receive Post-Conversion Material:</b> | TBD –Update in Q1'15 |
|---|----------------------|

## Description of Change to the Customer:

Intel is implementing changes on Intel® NUC Kit BLKDE3815TYKHE and Intel® NUC Board BLKDE3815TYKHOE to support Intel® Atom™ Processors E3815 B3 to DO stepping.

Please refer to PCN112949 for the changes.

## Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory.

Milestone dates are estimates and subject to change based on business and operational conditions.

## Products Affected / Intel Ordering Codes:

| Product Code    | Pre Change MM# | Pre Change TA | Pre Change AA | Post Change MM# | Post Change TA | Post Change AA |
|-----------------|----------------|---------------|---------------|-----------------|----------------|----------------|
| BLKDE3815TYKH0E | 933135         | TBD           | TBD           | TBD             | TBD            | TBD            |
| BLKDE3815TYBE   | 933136         | TBD           | TBD           | TBD             | TBD            | TBD            |

## Reference Documents / Attachments:

**Document:**

PCN112949

**Location #:**

<https://qdms.intel.com/Portal/SearchPCNDataBase.aspx>

## PCN Revision History:

**Date of Revision:**

September 18, 2014

**Revision Number:**

00

**Reason:**

Originally Published PCN